

REMARKS/ARGUMENTS

Claims 1-12 are pending in the application. Claims 1-12 have been amended. Claims 1-5 and 7-11 were rejected under 35 U.S.C. §102(b) as being anticipated by Albrecht et al, U.S. Patent No. 5,821,494 (hereinafter “Albrecht”). Claims 1-5 and 7-11 were rejected under 35 U.S.C. §102(b) as being anticipated by Ainslie et al, U.S. Patent No. 4,761,699 (hereinafter “Ainslie”). Claims 6 and 12 were rejected under 35 U.S.C. §103(a) as being unpatentable over Albrecht. Claims 6 and 12 were rejected under 35 U.S.C. §103(a) as being unpatentable over Ainslie.

Rejections under 35 U.S.C. §102

Claims 1-5 and 7-11 were rejected under 35 U.S.C. §102(b) as being anticipated by Albrecht. Albrecht discloses making a solder connection between a slider pad and a suspension pad is provided by forming a solder bump on the solder pad at the slider level to affix the slider to the suspension (See Abstract).

The Applicants respectfully traverse these rejections, in part, because Albrecht fails to teach or suggest the surface finishing material being heat treated prior to bonding to a surface, as called for in claims 1 and 7 as amended. The Examiner states, in regards to claims 1 and 7, that Albrecht discloses the invention as claimed. Albrecht states:

In FIG. 12A the slider 42 is affixed to the suspension 44 so that the slider pad 62 and the suspension pad 64 are adjacent one another for reflow of solder. A solder ball, produced at the end of the capillary from solder wire, is bumped against each of the slider pad 62 and the suspension pad 64 simultaneously to produce solder bump 122, as shown in FIG. 12B.

(See Albrecht, col. 10, lines 36-42).

In other words, a solder ball is placed between the slider pad and the suspension pad, at

which point the solder is used to create the bond. The solder is not a surface finishing material being heat treated prior to bonding to a surface. Therefore, Albrecht does not disclose the surface finishing material being heat treated prior to bonding to a surface, as set forth in claims 1 and 7. Since at least this feature of claims 1 and 7 is missing from Albrecht, the Albrecht reference fails to anticipate claims 1 and 7 under 35 U.S.C. §102(b). Applicant further respectfully submits that claims 2-5 and 8-11 are allowable as depending from the allowable base claims 1 and 7.

Claims 1-5 and 7-11 were further rejected under 35 U.S.C. §102(b) as being anticipated by Ainslie. Ainslie discloses mechanically attaching a slider to the suspension with reflowed solder balls. A pattern of solder contact pads is formed on the back side of the slider and a similar pattern of solder-wettable regions is formed on the suspension (*See Abstract*).

The Applicants respectfully traverse these rejections, in part, because Ainslie fails to teach or suggest a surface finishing material being heat treated prior to bonding to a surface, as called for in claims 1 and 7 as amended. The Examiner states, in regards to claims 1 and 7, that Ainslie discloses the invention as claimed. Ainslie states:

As shown in FIG. 4, each of the contact pads 70 comprises an adhesion film 74 formed directly onto the slider back side 24 and a solder-wettable film 76 formed on the adhesion film 74. The solder contact pads are formed on the slider back side by a suitable mask having openings which is placed over back side 24.

(See Ainslie, col. 4, lines 18-23).

If the solder balls are not to be formed for some time, then a corrosion-resistant film 78 of, for example, gold is formed over the nickel film.

(See Ainslie, col. 4, lines 18-23).

In other words, the solder wettable film or corrosion resistant film is not a surface finishing material being heat treated prior to bonding to a surface. Also, a bonding substance is

not applied as a surface finishing material. Further, Ainslie states:

Referring again to FIG. 3, the solder-wettable regions on suspension 40 are formed by removing selected portions of the polyimide insulating layer 48, which thereby exposes the circular openings 60, 61 on large area portions 52, 54 and the circular openings 63 on lead terminations 47.

(See Ainslie, col. 4, lines 18-23).

In other words, the suspension does not even have pads. Therefore, Ainslie does not disclose a surface finishing material being heat treated prior to bonding to a surface, as set forth in claims 1 and 7. Since at least this feature of claims 1 and 7 is missing from Ainslie, the Ainslie reference fails to anticipate claims 1 and 7 under 35 U.S.C. §102(b). Applicant further respectfully submits that claims 2-5 and 8-11 are allowable as depending from the allowable base claims 1 and 7.

Based on the arguments above, reconsideration and withdrawal of the rejection of claims 1-5 and 7-11 under 35 U.S.C. §102(b) is respectfully requested.

Rejections under 35 U.S.C. §103

Claims 6 and 12 were rejected under 35 U.S.C. §103(a) as being unpatentable over Albrecht or Ainslie. Claims 6 and 12 include a surface finishing material being heat treated prior to bonding to a surface, through dependency on claims 1 and 7, respectively. As stated above, Albrecht and Ainslie both fail to disclose, teach, or suggest this limitation. Therefore, claims 6 and 12 are not obvious in view of either Albrecht or Ainslie.

Based on the arguments above, reconsideration and withdrawal of the rejection of claims 6 and 12 under 35 U.S.C. §103(a) is respectfully requested.

It is believed that this Amendment places the application in condition for allowance, and

early favorable consideration of this Amendment is earnestly solicited.

If, in the opinion of the Examiner, an interview would expedite the prosecution of this application, the Examiner is invited to call the undersigned attorney at the telephone number listed below.

The Office is hereby authorized to charge any fees, or credit any overpayments, to Deposit Account No. **11-0600**.

Respectfully submitted,

KENYON & KENYON

Dated: June 30, 2003

By: Stephen T. Neal
Stephen T. Neal
(Reg. No. 47,815)

KENYON & KENYON
333 West San Carlos St., Suite 600
San Jose, CA 95110

Telephone: (408) 975-7500
Facsimile: (408) 975-7501